

### **Technical Data Sheet**

MODEL NO: Q776R4P-60mA-M 2.8 x 3.5 x 0.8mm Yellow SMD

### Features:

- ●3.5 X 3.5mm
- ●2000 pcs Per Reel
- Compatible with automatic placement equipment
- Compatible with reflow solder process

### Applications:

- Indicators
- Automotive: backlighting in dashboard and switch

Dice material	Emitted color	Lens Color
AlGaInP	Red	Water Clear

### Electrical/Optical Characteristics(Ta=25 $^{\circ}$ C)

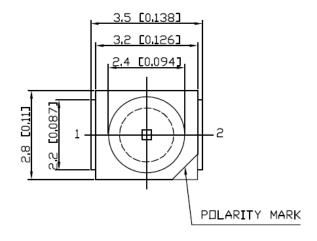
Parameter	Test	Symbol	Value			Unit
	Condition		Min	Тур	Max	Ullit
Dominant wavelength	IF=60mA	λD	617		629	nm
Forward voltage	IF=60mA	VF	2.0		2.8	V
Luminous Flux	IF=60mA	ф	8	10		lm
Viewing angle at 50% lv	IF=60mA	2 <i>0</i> 1/2		120		Deg
Reverse current	V <sub>R</sub> =5V	lr			10	μА

### Absolute Maximum Ratings(Ta=25℃)

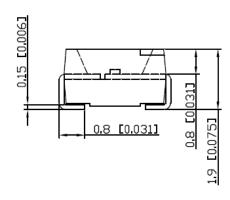
Parameter	Symbol	Value	Unit
Power dissipation	Pd	120	mW
Forward current	lF	60	mA
Reverse voltage	VR	5	V
Operating temperature range	Тор	-40 ~+85	$^{\circ}\!\mathbb{C}$
Storage temperature range	Tstg	-40 ~+85	$^{\circ}\!\mathbb{C}$
Peak pulsing current (Duty 1/10@1KHZ )[1]	<b>I</b> FP	100	mA



## PACKAGING DIMENSIONS (mm):





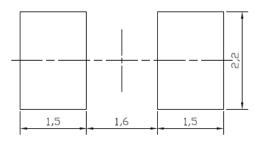


- 1. All dimension units are millimeters.
- 2. All dimension tolerance is ±0.2mm unless otherwise noted.

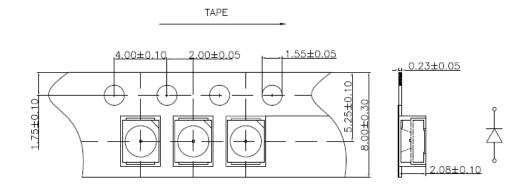


## Recommended soldering pattern

(Units:mm)



# ◆ Tape specifications (Units:mm)



### **Precautions For Use:**

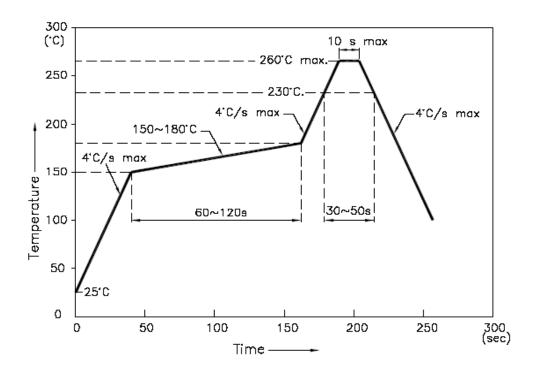
### Over - current - proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen)

### Storage

- 1. The operation of temperature and R.H. are :  $5^{\circ}$ C  $\sim 30^{\circ}$ C, 60%R.H. Max.
- 2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a dampproof box with desiccating regent. Considering the tape life, we suggest our customers to use our products within 1.5 year (from production date).
- 3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is :  $60^{\circ}\text{C}\pm5^{\circ}\text{C}$  for 15hrs.

### ■ Reflow Temp/Time



#### NOTES:

- 1. We recommend the reflow temperature  $245^{\circ}\text{C}(\pm 5^{\circ}\text{C})$ .the maximum soldering temperature should be limited to  $260^{\circ}\text{C}$ .
- 2. dont cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

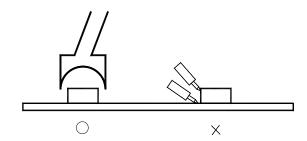


### ■Soldering iron

Basic spec is  $\leq$  5sec when 260°C. If temperature is higher, time should be shorter (+10°C  $\rightarrow$  -1sec ). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 230°C.

### **■**Rework

- 1. Customer must finish rework within 5 sec under 260°C.
- 2. The head of iron can not touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow \ solder etc.